TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# **TC7W241FU**

#### Non-Inverted, 3-State Outputs

The TC7W241FU is a high speed C<sup>2</sup>MOS Dual Bus Buffers fabricated with silicon gate C<sup>2</sup>MOS technology.

It achieves the high speed operation similar to equivalent LSTTL while maintaining the C<sup>2</sup>MOS low power dissipation.

It is a non-inverting 3-state buffer has one active-high and one active-low output enable.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

# SSOP8-P-0.65

Weight: 0.02 g (typ.)

#### **Features**

- High speed:  $t_{pd} = 10 \text{ ns (typ.)}$  at  $V_{CC} = 5 \text{ V}$
- Low power dissipation:  $I_{CC} = 2 \mu A \text{ (max)}$  at  $T_{a} = 25 \text{°C}$
- High noise immunity: VNIH = VNIL = 28% VCC (min)
- Output drive capability: 15 LSTTL loads
- Symmetrical output impedance: | I<sub>OH</sub> | = I<sub>OL</sub> = 6 mA (min)
- Balanced propagation delays:  $t_pLH \simeq t_pHL$
- Wide operating voltage range: VCC (opr) = 2 to 6 V

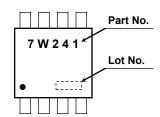
#### Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Supply voltage range	V <sub>CC</sub>	–0.5 to 7	V
DC input voltage	V <sub>IN</sub>	$-0.5$ to $V_{CC} + 0.5$	V
DC output voltage	V <sub>OUT</sub>	$-0.5$ to $V_{CC}$ + $0.5$	V
Input diode current	I <sub>IK</sub>	±20	mA
Output diode current	lok	±20	mA
DC output current	lout	±35	mA
DC V <sub>CC</sub> /ground current	I <sub>CC</sub>	±37.5	mA
Power dissipation	P <sub>D</sub>	300	mW
Storage temperature range	T <sub>stg</sub>	-65 to 150	°C
Lead temperature (10 s)	TL	260	°C

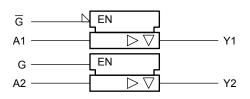
Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

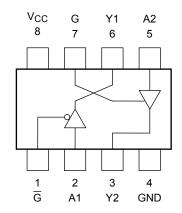
# Marking



# **Logic Diagram**



# Pin Configuration (top view)



#### **Truth Table**

	Output		
G	G	Α	Y
L	Н	L	L
L	Н	Н	Н
Н	L	Х	Z

X: Don't care

Z: High impedance

# **Operating Ranges**

Characteristics	Symbol	Rating	Unit
Supply voltage	V <sub>CC</sub>	2 to 6	V
Input voltage	V <sub>IN</sub>	0 to V <sub>CC</sub>	٧
Output voltage	V <sub>OUT</sub>	0 to V <sub>CC</sub>	<b>V</b>
Operating temperature range	T <sub>opr</sub>	-40 to 85	°C
		0 to 1000 (V <sub>CC</sub> = 2.0 V)	ns
Input rise and fall time	t <sub>r</sub> , t <sub>f</sub>	0 to 500 (V <sub>CC</sub> = 4.5 V)	
		0 to 400 (V <sub>CC</sub> = 6.0 V)	

# **Electrical Characteristics**

#### **DC Electrical Characteristics**

Characteristics Symbol Test Condition		Symbol	Test Condition			Ta = 25°C			Ta = -40 to 85°C		Unit
		V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	01110			
			_		2.0	1.5	_	_	1.5	_	
Hi	High level	V <sub>IH</sub>			4.5	3.15	_	_	3.15	_	
Input voltage					6.0	4.2	_	_	4.2	_	V
Input voltage			_		2.0		_	0.5	_	0.5	V
	Low level	VIL			4.5		_	1.35	_	1.35	
					6.0		_	1.8	_	1.8	
			V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	Ι <sub>ΟΗ</sub> = -20 μΑ	2.0	1.9	2.0		1.9		V
	High level	Vон			4.5	4.4	4.5	_	4.4	_	
Output					6.0	5.9	6.0	_	5.9	_	
				$I_{OH} = -6 \text{ mA}$	4.5	4.18	4.31	_	4.13	_	
				$I_{OH} = -7.8 \text{ mA}$	6.0	5.68	5.80	_	5.63	_	
voltage	Low level	V <sub>OL</sub>	V <sub>IN</sub> =	Ι <sub>ΟL</sub> = 20 μΑ	2.0		0	0.1	_	0.1	
					4.5		0	0.1	_	0.1	
					6.0	_	0	0.1	_	0.1	
				$I_{OL} = 6 \text{ mA}$	4.5	_	0.17	0.26	_	0.33	
				$I_{OL} = 7.8 \text{ mA}$	6.0	_	0.18	0.26	_	0.33	
3-state output off-state current		loz	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = V_{CC} \text{ or GND}$		6.0	_	_	±0.5	_	±5.0	μА
Input leakage of	current	I <sub>IN</sub>	V <sub>IN</sub> = V <sub>CC</sub> o	r GND	6.0		_	±0.1	_	±1.0	μА
Quiescent supply current $I_{CC}$ $V_{IN} = V_{CC}$ or GND		6.0	_	_	2.0	_	20.0	μА			



# AC Electrical Characteristics (input $t_r = t_f = 6 \text{ ns}$ )

Characteristics	Symbol	Test Condition			Ta = 25°C			Ta = -40 to 85°C		Unit
	- Cy20.	Tool condition	C <sub>L(pF)</sub>	V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	0
		_	50	2.0	_	25	60	_	75	ns
Output transition time	t <sub>TLH</sub>			4.5	_	7	12	_	15	
	TITLE			6.0		6	10	_	13	
			50	2.0		36	90	_	115	
				4.5	_	12	18	_	23	ns
Propagation delay time	t <sub>pLH</sub>			6.0	_	10	15	_	20	
Tropagation delay time	t <sub>pHL</sub>	_		2.0	_	51	130	_	165	
			150	4.5	_	17	26	_	33	ns
				6.0	_	14	22	_	28	
	t <sub>pZL</sub>	$R_L = 1 \text{ k}\Omega$	50	2.0	_	48	125	_	155	ns
				4.5	_	16	25	_	31	
Output enable time				6.0	_	14	21	_	26	
Output enable time	t <sub>pZH</sub>		150	2.0	_	63	165	_	205	
				4.5	_	21	33	_	41	
				6.0	_	18	28	_	35	
Output disable time	t <sub>pLZ</sub> t <sub>pHZ</sub>	$R_L = 1 \text{ k}\Omega$	50	2.0	_	32	125	_	155	ns
				4.5	_	15	25	_	31	
				6.0	_	14	21	_	26	
Input capacitance	C <sub>IN</sub>	_	_	_	_	5	10	_	10	pF
Output capacitance	C <sub>OUT</sub>	_		_	_	10	_	_	_	pF
Power dissipation capacitance	C <sub>PD</sub>	(Note)	_	_	_	33	_	_	_	pF

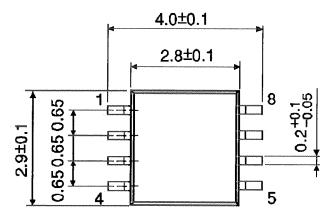
Note: C<sub>PD</sub> is defined as the value of internal equivalent capacitance which is calculated from the operating current consumption without load.

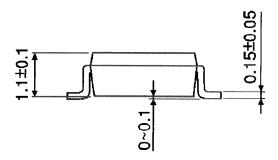
Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/2 \text{ (per gate)}$ 

# **Package Dimensions**

SSOP8-P-0.65 Unit: mm





5

Weight: 0.02 g (typ.)

#### **RESTRICTIONS ON PRODUCT USE**

- Toshiba Corporation, and its subsidiaries and affiliates (collectively "TOSHIBA"), reserve the right to make changes to the information
  in this document, and related hardware, software and systems (collectively "Product") without notice.
- This document and any information herein may not be reproduced without prior written permission from TOSHIBA. Even with TOSHIBA's written permission, reproduction is permissible only if reproduction is without alteration/omission.
- Though TOSHIBA works continually to improve Product's quality and reliability, Product can malfunction or fail. Customers are responsible for complying with safety standards and for providing adequate designs and safeguards for their hardware, software and systems which minimize risk and avoid situations in which a malfunction or failure of Product could cause loss of human life, bodily injury or damage to property, including data loss or corruption. Before customers use the Product, create designs including the Product, or incorporate the Product into their own applications, customers must also refer to and comply with (a) the latest versions of all relevant TOSHIBA information, including without limitation, this document, the specifications, the data sheets and application notes for Product and the precautions and conditions set forth in the "TOSHIBA Semiconductor Reliability Handbook" and (b) the instructions for the application with which the Product will be used with or for. Customers are solely responsible for all aspects of their own product design or applications, including but not limited to (a) determining the appropriateness of the use of this Product in such design or applications; (b) evaluating and determining the applicability of any information contained in this document, or in charts, diagrams, programs, algorithms, sample application circuits, or any other referenced documents; and (c) validating all operating parameters for such designs and applications. TOSHIBA ASSUMES NO LIABILITY FOR CUSTOMERS' PRODUCT DESIGN OR APPLICATIONS.
- PRODUCT IS NEITHER INTENDED NOR WARRANTED FOR USE IN EQUIPMENTS OR SYSTEMS THAT REQUIRE
  EXTRAORDINARILY HIGH LEVELS OF QUALITY AND/OR RELIABILITY, AND/OR A MALFUNCTION OR FAILURE OF WHICH
  MAY CAUSE LOSS OF HUMAN LIFE, BODILY INJURY, SERIOUS PROPERTY DAMAGE AND/OR SERIOUS PUBLIC IMPACT
  ("UNINTENDED USE"). Except for specific applications as expressly stated in this document, Unintended Use includes, without
  limitation, equipment used in nuclear facilities, equipment used in the aerospace industry, medical equipment, equipment used for
  automobiles, trains, ships and other transportation, traffic signaling equipment, equipment used to control combustions or explosions,
  safety devices, elevators and escalators, devices related to electric power, and equipment used in finance-related fields. IF YOU USE
  PRODUCT FOR UNINTENDED USE, TOSHIBA ASSUMES NO LIABILITY FOR PRODUCT. For details, please contact your
  TOSHIBA sales representative.
- . Do not disassemble, analyze, reverse-engineer, alter, modify, translate or copy Product, whether in whole or in part.
- Product shall not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any
  applicable laws or regulations.
- The information contained herein is presented only as guidance for Product use. No responsibility is assumed by TOSHIBA for any infringement of patents or any other intellectual property rights of third parties that may result from the use of Product. No license to any intellectual property right is granted by this document, whether express or implied, by estoppel or otherwise.
- ABSENT A WRITTEN SIGNED AGREEMENT, EXCEPT AS PROVIDED IN THE RELEVANT TERMS AND CONDITIONS OF SALE
  FOR PRODUCT, AND TO THE MAXIMUM EXTENT ALLOWABLE BY LAW, TOSHIBA (1) ASSUMES NO LIABILITY
  WHATSOEVER, INCLUDING WITHOUT LIMITATION, INDIRECT, CONSEQUENTIAL, SPECIAL, OR INCIDENTAL DAMAGES OR
  LOSS, INCLUDING WITHOUT LIMITATION, LOSS OF PROFITS, LOSS OF OPPORTUNITIES, BUSINESS INTERRUPTION AND
  LOSS OF DATA, AND (2) DISCLAIMS ANY AND ALL EXPRESS OR IMPLIED WARRANTIES AND CONDITIONS RELATED TO
  SALE, USE OF PRODUCT, OR INFORMATION, INCLUDING WARRANTIES OR CONDITIONS OF MERCHANTABILITY, FITNESS
  FOR A PARTICULAR PURPOSE, ACCURACY OF INFORMATION, OR NONINFRINGEMENT.
- Do not use or otherwise make available Product or related software or technology for any military purposes, including without limitation, for the design, development, use, stockpiling or manufacturing of nuclear, chemical, or biological weapons or missile technology products (mass destruction weapons). Product and related software and technology may be controlled under the applicable export laws and regulations including, without limitation, the Japanese Foreign Exchange and Foreign Trade Law and the U.S. Export Administration Regulations. Export and re-export of Product or related software or technology are strictly prohibited except in compliance with all applicable export laws and regulations.
- Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product.
   Please use Product in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive. TOSHIBA ASSUMES NO LIABILITY FOR DAMAGES OR LOSSES
   OCCURRING AS A RESULT OF NONCOMPLIANCE WITH APPLICABLE LAWS AND REGULATIONS.

6

# **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Buffers & Line Drivers category:

Click to view products by Toshiba manufacturer:

Other Similar products are found below:

LXV200-024SW 74AUP2G34FW3-7 HEF4043BP NLU1GT126CMUTCG PI74FCT3244L MC74HCT365ADTR2G Le87401NQC

Le87402MQC 028192B 042140C 051117G 070519XB NL17SZ07P5T5G NLU1GT126AMUTCG 74AUP1G17FW5-7 74LVC2G17FW4-7

CD4502BE 5962-8982101PA 5962-9052201PA 74LVC1G125FW4-7 NL17SH17P5T5G NL17SH125P5T5G NLV37WZ07USG

RHRXH162244K1 74AUP1G34FW5-7 74AUP1G07FW5-7 74LVC2G126RA3-7 NLX2G17CMUTCG 74LVCE1G125FZ4-7 Le87501NQC

74AUP1G126FW5-7 TC74HC4050AP(F) 74LVCE1G07FZ4-7 NLX3G16DMUTCG NLX2G06AMUTCG NLVVHC1G50DFT2G

NLU2G17AMUTCG LE87100NQC LE87290YQC LE87290YQCT LE87511NQC LE87511NQCT LE87557NQC LE87557NQCT

LE87614MQC LE87614MQCT 74AUP1G125FW5-7 NLU2G16CMUTCG MC74LCX244MN2TWG NLV74VHC125DTR2G